

### N and P-Channel Enhancement Mode Power MOSFET

## **Description**

The NCE20NP1006S uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

#### **General Features**

#### N-Channel

 $V_{DS} = 20V, I_{D} = 10A$ 

 $R_{DS(ON)}$  < 14m $\Omega$  @  $V_{GS}$ =4.5V

 $R_{DS(ON)}$  < 18m $\Omega$  @  $V_{GS}$ =2.5V

#### P-Channel

 $V_{DS} = -20V, I_{D} = -6A$ 

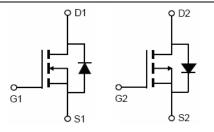
 $R_{DS(ON)}$  < 45m $\Omega$  @  $V_{GS}$ =-4.5V

 $R_{DS(ON)} < 60 \text{m}\Omega$  @  $V_{GS}$ =-2.5V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- Pb free terminal plating
- RoHS compliant
- Halogen free

### **Application**

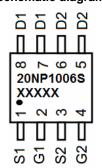
Power Management



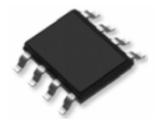
N-channel

P-channel

#### Schematic diagram



### Marking and pin assignment



SOP-8 top view

**Package Marking and Ordering Information** 

| Device Marking | Device       | Device Package | Reel Size | Tape width | Quantity   |
|----------------|--------------|----------------|-----------|------------|------------|
| 20NP1006S      | NCE20NP1006S | SOP-8          | Ø330mm    | 12mm       | 4000 units |

Absolute Maximum Ratings (T<sub>4</sub>=25 °C unless otherwise noted)

| The series of th |                      |                     |            |            |                        |  |
|--|----------------------|---------------------|------------|------------|------------------------|--|
| Parameter  |                      | Symbol              | N-Channel  | P-Channel  | Unit                   |  |
| Drain-Source Voltage   | $V_{DS}$             | 20                  | -20        | V          |                        |  |
| Gate-Source Voltage  |                      | V <sub>GS</sub>     | ±12        | ±12        | V                      |  |
| Continuous Drain Current   | T <sub>A</sub> =25℃  |                     | 10         | -6         | ^                      |  |
| Continuous Drain Current   | T <sub>A</sub> =70℃  | I <sub>D</sub>      | 8          | -4.8       | Α                      |  |
| Pulsed Drain Current (Note 1)  |                      | I <sub>DM</sub>     | 40         | -30        | Α                      |  |
| Maximum Power Dissipation  | T <sub>A</sub> =25°C | P <sub>D</sub>      | 2.0        | 2.0        | W                      |  |
| Operating Junction and Storage   | Temperature Range    | $T_{J}$ , $T_{STG}$ | -55 To 150 | -55 To 150 | $^{\circ}\!\mathbb{C}$ |  |

### **Thermal Characteristic**

| Thermal Resistance,Junction-to-Ambient (Note2)  | R <sub>0JA</sub> | N-Ch | 62.5 | °C/W |
|---|------------------|------|------|------|
| Thermal Resistance, Junction-to-Ambient (Note2) | $R_{	hetaJA}$    | P-Ch | 62.5 | °C/W |

# NCE20NP1006S

# N-CH Electrical Characteristics ( $T_A$ =25 $^{\circ}$ C unless otherwise noted)

| Parameter                          | Symbol              | Condition                                      | Min | Тур  | Max  | Unit |
|------------------------------------|---------------------|--|-----|------|------|------|
| Off Characteristics                |                     |  |     |      |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA      | 20  | -    | -    | V    |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    | V <sub>DS</sub> =20V,V <sub>GS</sub> =0V       | -   | -    | 1    | μA   |
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | V <sub>GS</sub> =±12V,V <sub>DS</sub> =0V      | -   | -    | ±100 | nA   |
| On Characteristics (Note 3)        |                     |  |     |      |      |      |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | $V_{DS}=V_{GS},I_{D}=250\mu A$                 | 0.5 | 0.7  | 1.0  | V    |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A     | -   | 12   | 14   | mΩ   |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =2.5V, I <sub>D</sub> =5A      | -   | 13.5 | 18   | mΩ   |
| Gate resistance                    | R <sub>G</sub>      |  | -   | -    | 10   | Ω    |
| Forward Transconductance           | <b>g</b> FS         | V <sub>DS</sub> =5V,I <sub>D</sub> =10A        | 10  | -    | -    | S    |
| Dynamic Characteristics (Note4)    |                     |  |     |      |      |      |
| Input Capacitance                  | C <sub>lss</sub>    | \/ -10\/\/ -0\/                                | -   | 691  | -    | PF   |
| Output Capacitance                 | C <sub>oss</sub>    | $V_{DS}$ =10V, $V_{GS}$ =0V,<br>F=1.0MHz       | -   | 128  | -    | PF   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    | r-1.0ivinz                                     | -   | 115  | -    | PF   |
| Switching Characteristics (Note 4) |                     |  |     |      |      |      |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  |  | -   | 9    | -    | nS   |
| Turn-on Rise Time                  | t <sub>r</sub>      | $V_{DD}$ =10V, $R_L$ =2 $\Omega$               | -   | 13   | -    | nS   |
| Turn-Off Delay Time                | t <sub>d(off)</sub> | $V_{GS}$ =4.5 $V$ , $R_{GEN}$ =3 $\Omega$      | -   | 14.5 | -    | nS   |
| Turn-Off Fall Time                 | t <sub>f</sub>      |  | -   | 3.2  | -    | nS   |
| Total Gate Charge                  | Qg                  | V 40V/1 40A                                    | -   | 10.2 | -    | nC   |
| Gate-Source Charge                 | Q <sub>gs</sub>     | $V_{DS}$ =10V, $I_{D}$ =10A,<br>$V_{GS}$ =4.5V | -   | 1.1  | -    | nC   |
| Gate-Drain Charge                  | $Q_{gd}$            | VGS=4.5V                                       | -   | 3.7  | -    | nC   |
| Drain-Source Diode Characteristics |                     |  | •   | •    |      | -    |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =10A        | -   | 0.8  | 1.2  | V    |

# NCE20NP1006S

# P-CH Electrical Characteristics (T<sub>A</sub>=25 <sup>°</sup>C unless otherwise noted)

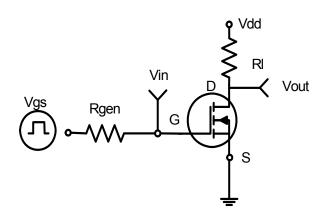
| Symbol              | Condition   | Min  | Тур   | Max               | Unit              |  |  |
|---------------------|---|--|---|-------------------|-------------------|--|--|
| Off Characteristics |   |  |   |                   |                   |  |  |
| BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =-250μA  | -20  | -   | -                 | V                 |  |  |
| I <sub>DSS</sub>    | V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V   | -  | -   | -1                | μA                |  |  |
| I <sub>GSS</sub>    | V <sub>GS</sub> =±12V,V <sub>DS</sub> =0V   | -  | -   | ±100              | nA                |  |  |
|                     |   |  | •   |                   |                   |  |  |
| $V_{GS(th)}$        | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA                                  | -0.5   | -0.7  | -1.0              | V                 |  |  |
| D                   | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-6A   | -  | 34  | 45                | mΩ                |  |  |
| R <sub>DS(ON)</sub> | V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-5A   | -  | 44  | 60                | mΩ                |  |  |
| $R_G$               |   | -  | -   | 15                | Ω                 |  |  |
| <b>g</b> FS         | V <sub>DS</sub> =-5V,I <sub>D</sub> =-6A  | 6  | -   | -                 | S                 |  |  |
|                     |   |  |   |                   |                   |  |  |
| C <sub>lss</sub>    | \/ - 40\/\/ -0\/  | -  | 550   | -                 | PF                |  |  |
| Coss                | ,   | -  | 93  | -                 | PF                |  |  |
| C <sub>rss</sub>    | r=1.0lvinz  | -  | 64  | -                 | PF                |  |  |
|                     |   |  |   |                   |                   |  |  |
| t <sub>d(on)</sub>  |   | -  | 7   | -                 | nS                |  |  |
| t <sub>r</sub>      | $V_{DD}$ =-10 $V$ , $R_L$ =5 $\Omega$   | -  | 13  | -                 | nS                |  |  |
| t <sub>d(off)</sub> | $V_{GS}$ =-4.5 $V$ , $R_{GEN}$ =6 $\Omega$  | -  | 12  | -                 | nS                |  |  |
| t <sub>f</sub>      |   | -  | 3   | -                 | nS                |  |  |
| $Q_g$               | \/ - 40\/ I - 6A  | -  | 7   | -                 | nC                |  |  |
| Q <sub>gs</sub>     |   | -  | 1.1   | -                 | nC                |  |  |
| $Q_{gd}$            | VGS=-4.3V   | -  | 1.8   | -                 | nC                |  |  |
|                     |   |  |   |                   |                   |  |  |
| $V_{SD}$            | V <sub>GS</sub> =0V,I <sub>S</sub> =-6A   | -  | -   | -1.2              | V                 |  |  |
|                     | BVDSS IDSS IGSS VGS(th) RDS(ON) RG GFS Clss Coss Crss td(on) tr td(off) tf Qg Qgs Qgs Qgd | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | BV <sub>DSS</sub> | BV <sub>DSS</sub> |  |  |

### Notes:

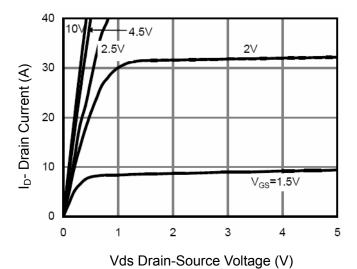
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



# N- Channel Typical Electrical and Thermal Characteristics (Curves)



**Figure 1:Switching Test Circuit** 



**Figure 3 Output Characteristics** 

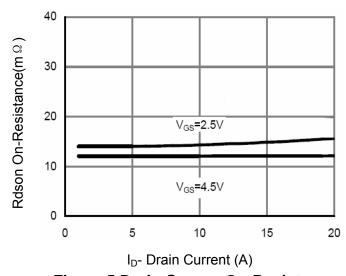


Figure 5 Drain-Source On-Resistance

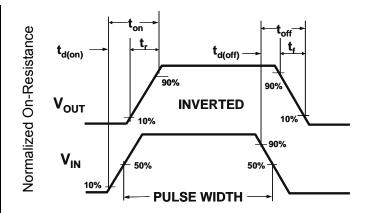
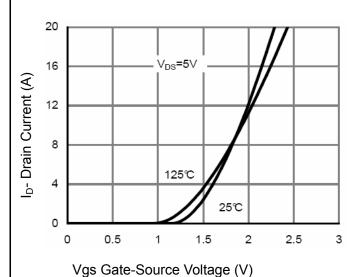


Figure 2:Switching Waveforms



**Figure 4 Transfer Characteristics** 

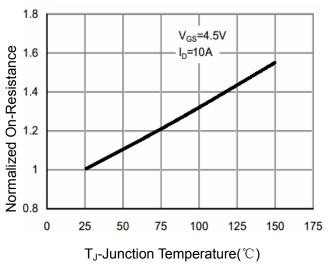


Figure 6 Drain-Source On-Resistance



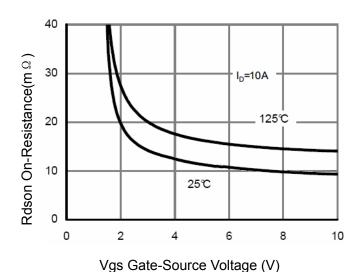


Figure7 Rdson vs Vgs

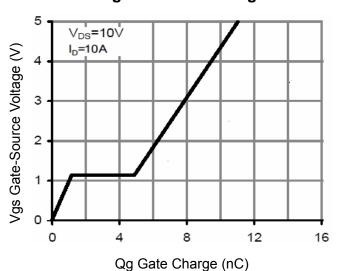


Figure 9 Gate Charge

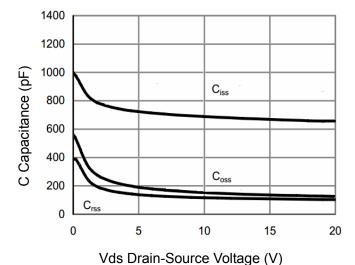
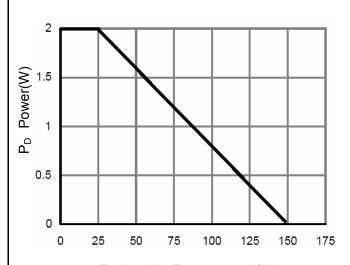


Figure 11 Capacitance vs Vds



 $T_J$ -Junction Temperature( $^{\circ}$ C) Figure 8 Power Dissipation

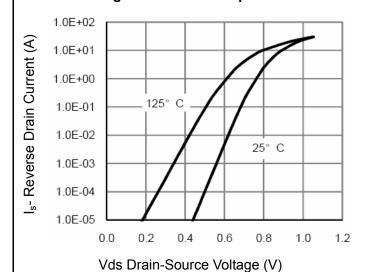
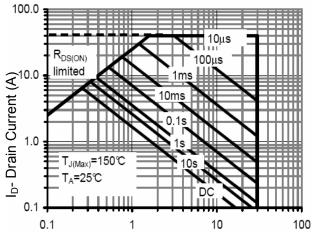


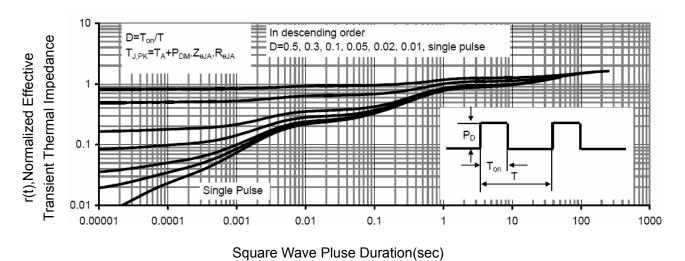
Figure 10 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)

Figure 12 Safe Operation Area

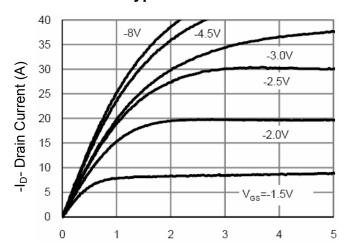




**Figure 13 Normalized Maximum Transient Thermal Impedance** 

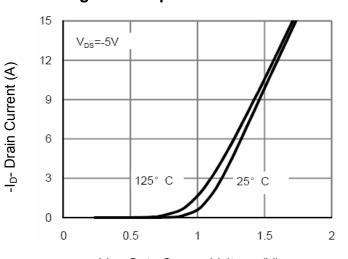


## P- Channel Typical Electrical and Thermal Characteristics (Curves)



-Vds Drain-Source Voltage (V)

**Figure 1 Output Characteristics** 



-Vgs Gate-Source Voltage (V)

**Figure 2 Transfer Characteristics** 

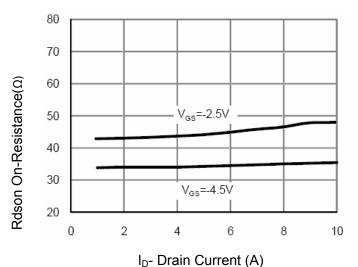
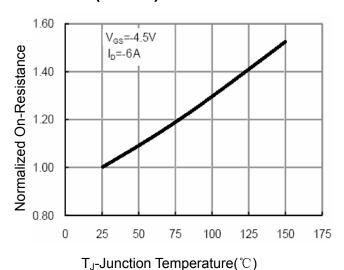
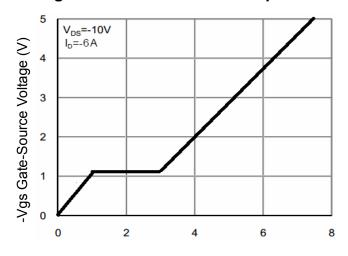


Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 



Qg Gate Charge (nC)
Figure 5 Gate Charge

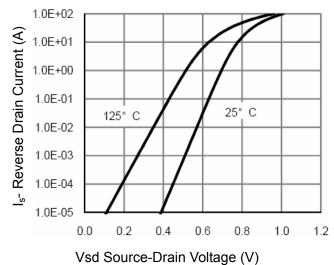


Figure 6 Source- Drain Diode Forward



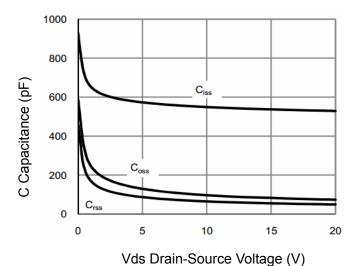


Figure 7 Capacitance vs Vds

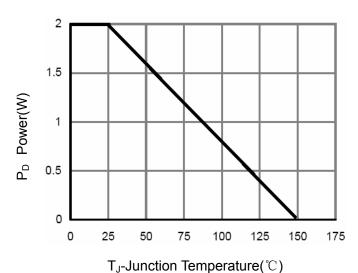


Figure 9 Power Dissipation

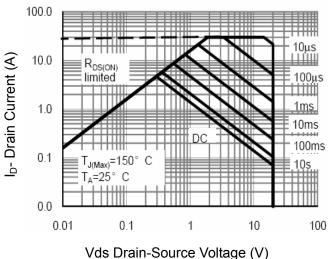


Figure 8 Safe Operation Area

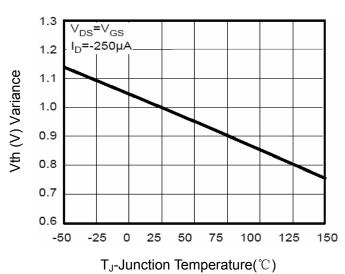
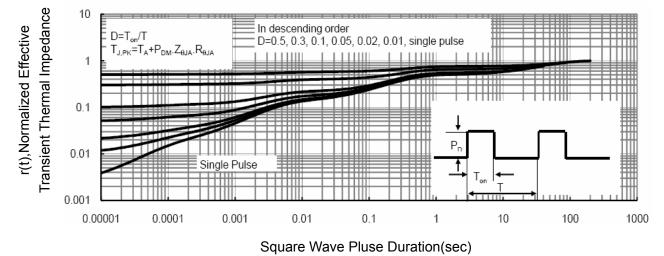


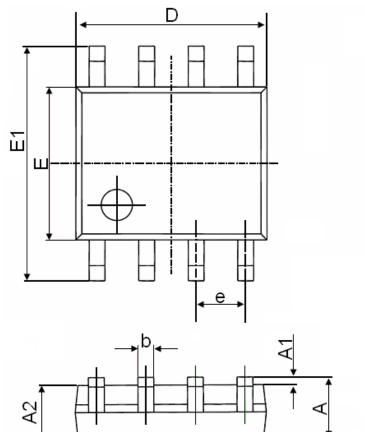
Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

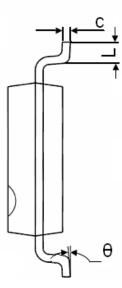


**Figure 11 Normalized Maximum Transient Thermal Impedance** 



# **SOP-8 Package Information**





| Cumbal | Dimensions | In Millimeters | Dimensions In Inches |       |  |
|--------|------------|----------------|----------------------|-------|--|
| Symbol | Min.       | Max.           | Min.                 | Max.  |  |
| Α      | 1.450      | 1.750          | 0.057                | 0.069 |  |
| A1     | 0.100      | 0.250          | 0.004                | 0.010 |  |
| A2     | 1.350      | 1.550          | 0.053                | 0.061 |  |
| b      | 0.330      | 0.510          | 0.013                | 0.020 |  |
| С      | 0.170      | 0.250          | 0.006                | 0.010 |  |
| D      | 4.700      | 5.100          | 0.185                | 0.201 |  |
| E      | 3.800      | 4.000          | 0.150                | 0.157 |  |
| E1     | 5.800      | 6.200          | 0.228                | 0.244 |  |
| е      | 1.270      | (BSC)          | 0.050(BSC)           |       |  |
| L      | 0.400      | 1.270          | 0.016                | 0.050 |  |
| θ      | 0°         | 8°             | 0°                   | 8°    |  |

### http://www.ncepower.com

# NCE20NP1006S

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